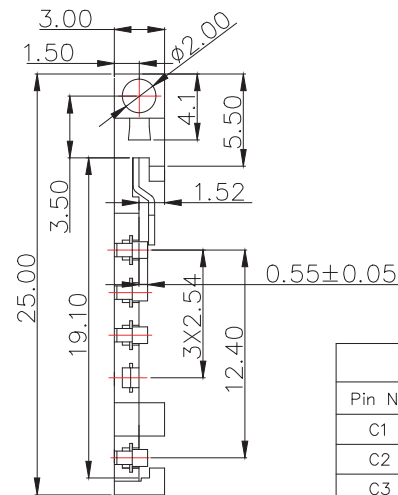
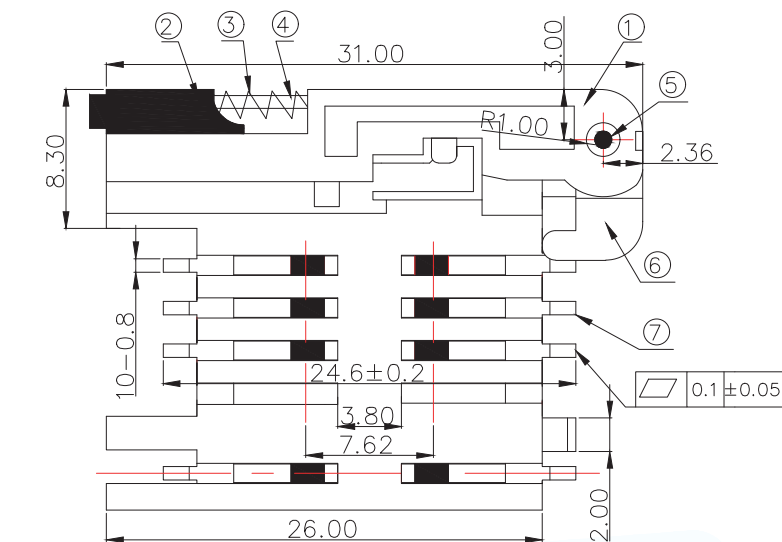




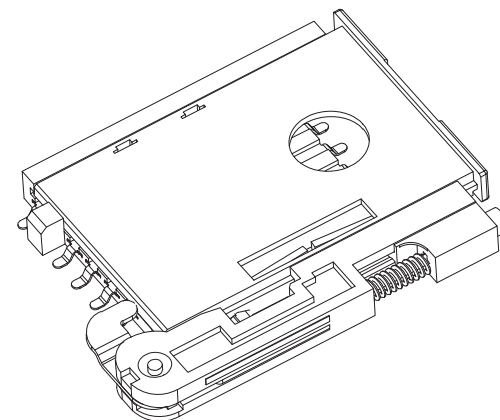
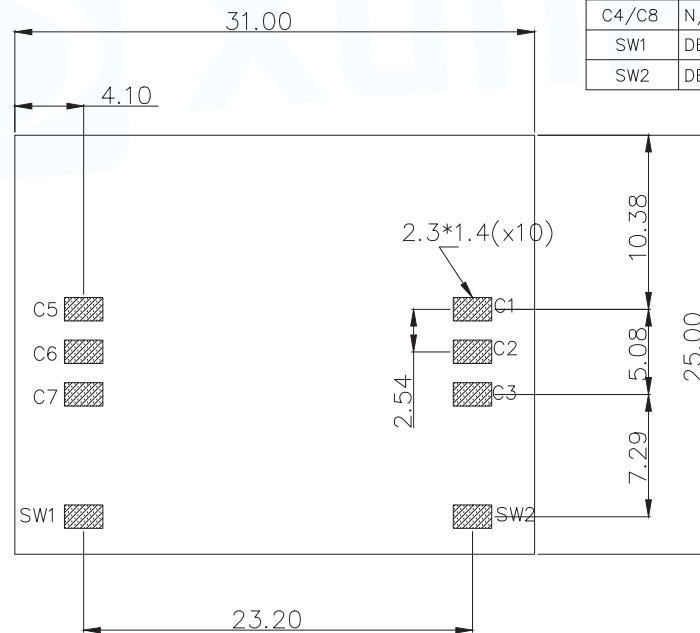
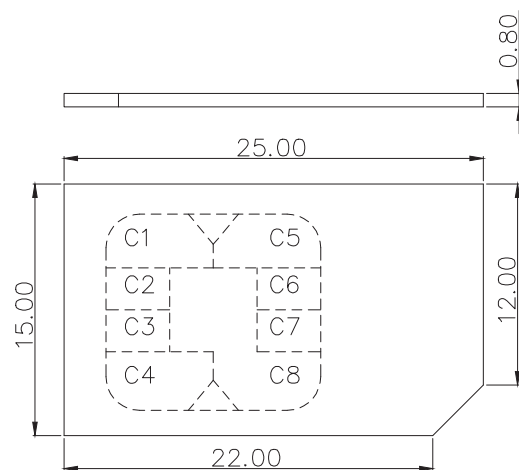
MINI SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
SW1	DETECTION SWITCH1
SW2	DETECTION SWITCH2

技术要求:

- 产品外观无脏污, 刮伤, 变形现象
- 塑体无毛边, 未射饱; 端子无氧化, 生锈现象

备注:

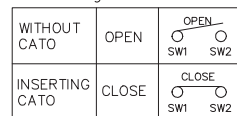
簧片镀金层的厚度可根据客户的需求做变更

插卡方向
焊脚朝下

▨ PAD AREA
■ KEEP OUT AREA

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

Circuit Diagram for Detect Switch



7	簧片	磷铜	8	底层镀Ni; 表面局部镀Au
6	Z形片	不锈钢	1	
5	小轴	黄铜	1	
4	推杆	锰钢	1	
3	弹簧	不锈钢	1	
2	按钮	LCP	1	
1	支架	LCP/PPS	1	手工焊: 材料为PPS 波峰焊: 材料为LCP
序号	名称	材料	数量	备注

MANUFACTURE DWG

UNLESS OTHERWISE
SPECIFIED TOLERANCES

DECIMALS:

X.: ±0.20

X.X: ±0.15

X.XX: ±0.10

ANGLES:

X.°: ±1°

X.X°: ±0.5°

TITLE: MINI SIM CARD 6+2P
推杆式

PAR SIM-121

DWN

CHKD

APVD

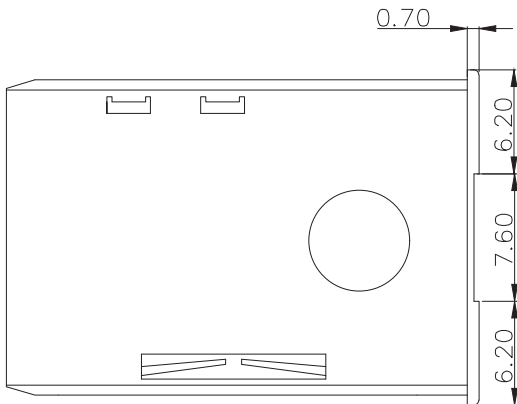
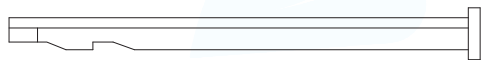
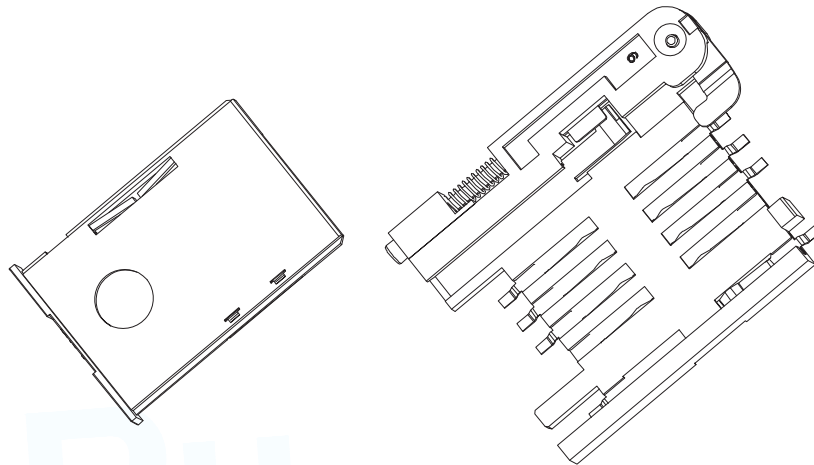
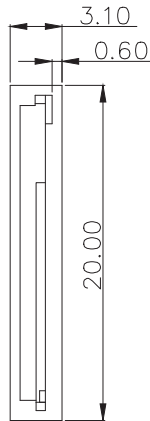
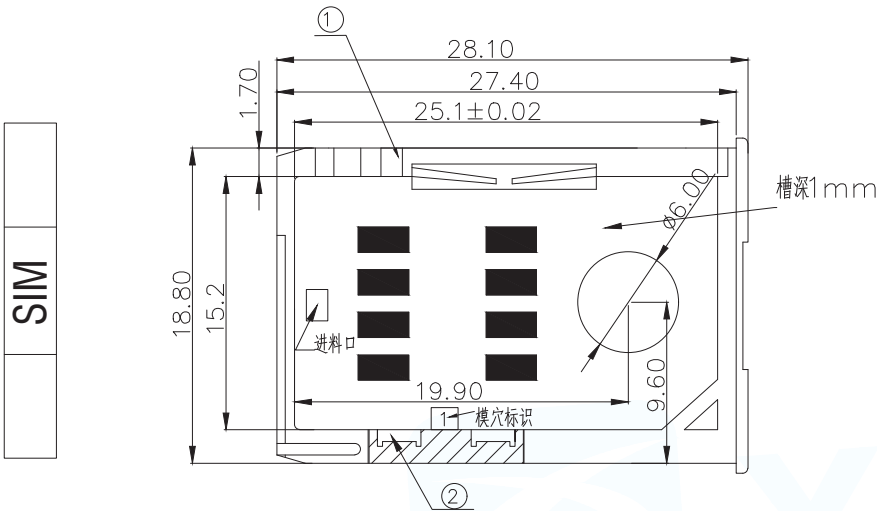
SCALE: 1:1

UNIT: MM

SIZE: A4

SHEET: 1F2

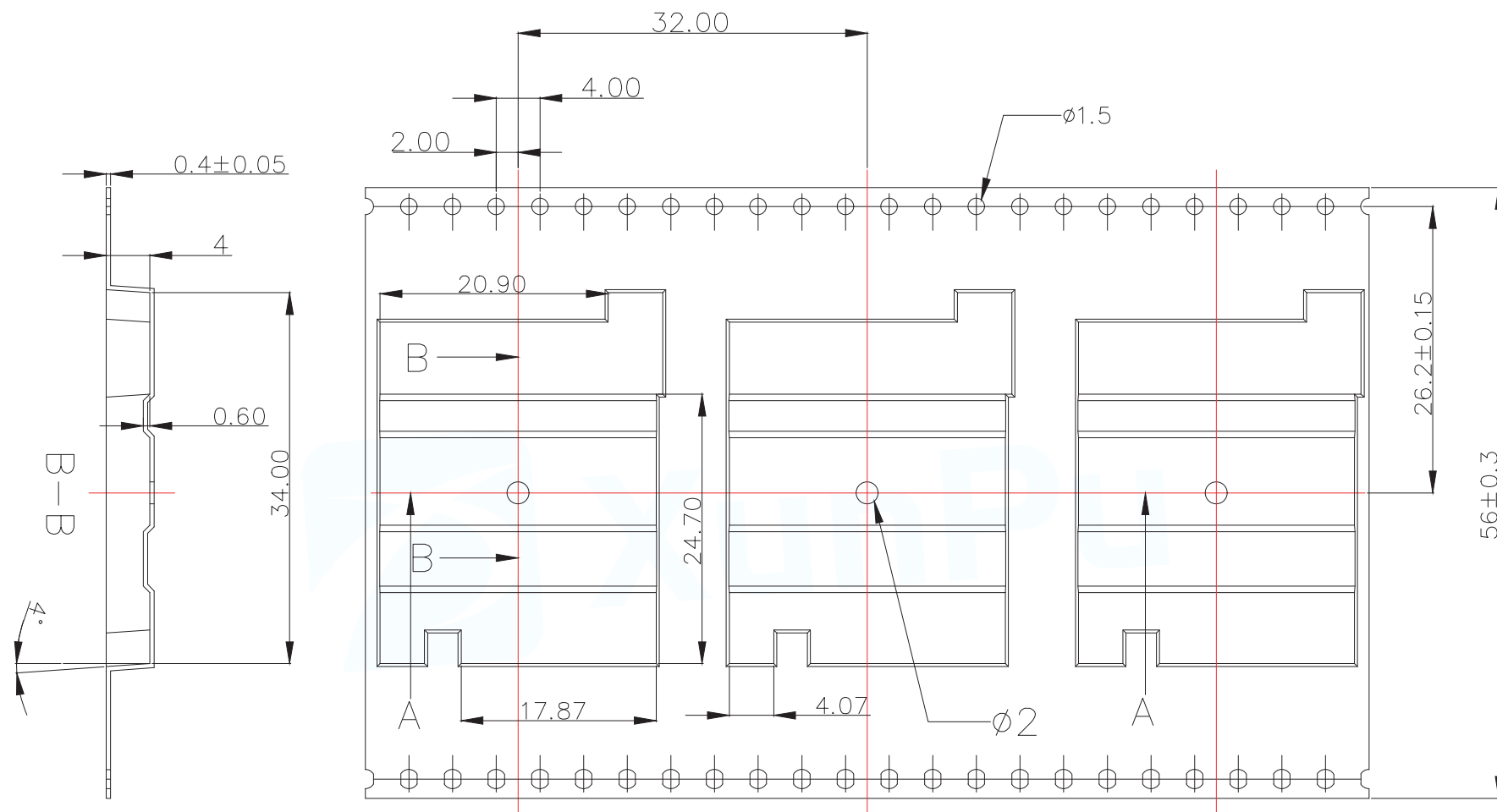
REV: A



技术要求:

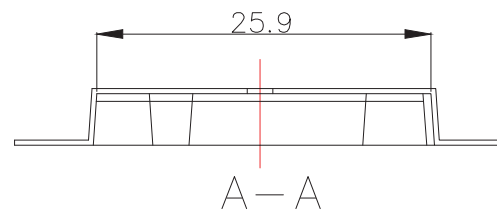
1. 产品外观无脏污, 刮伤, 变形现象
2. 塑体无毛边, 未射饱; 接触片无氧化, 生锈现象

2	接触片	磷铜	1	底层Ni≥100 μ”，表层Au, 厚度为≥15 μ”					
1	抽屉	PC	1						
序号	名称	材料	数量	备注					
MANUFACTURE DWG		TITLE: MINI SIM CARD 6+2P 推杆式							
UNLESS OTHERWISE SPECIFIED TOLERANCES									
DECIMALS:						PAR		SIM-121 盖板	
ANGLES:						DWN			
X.: ±0.20						CHKD			
X.X: ±0.15		APVD							
X.XX: ±0.1		SCALE1: 1		UNIT: MM					
		CUSTOMER COPY		SIZE: A4		SHEET: 2F2			
				REV: A					



注:

1. 载带10个边孔公差累计不能超过 $\pm 0.2\text{MM}$.
 2. 表面: 表面平整无凹凸, 无毛屑.
 3. 弯曲度: 直尺测量任意1M、弯曲度不超3MM.
 4. 韧性: 反复对折后、侧面无缺口.
 5. 材料: 黑色导电PS.
- 卷轮包装零件总颗数: 510 颗. (实际包装零件颗数: 500颗).



MANUFACTURE DWG		TITLE: MINI SIM CARD 6+2P 推杆式 包装图		
UNLESS OTHERWISE SPECIFIED TOLERANCES		PAR	SIM-121 包装图	
		DWN		
		CHKD		
		APVD		
		SCALE: 1:1	UNIT: MM	
DECIMALS:	ANGLES:	CUSTOMER COPY		
X.: ± 0.20	X.: $\pm 1^\circ$	SIZE: A4	SHEET: 2F2	REV: A
X.X: ± 0.15	X.X': $\pm 0.5^\circ$			
X.XX: ± 0.1				